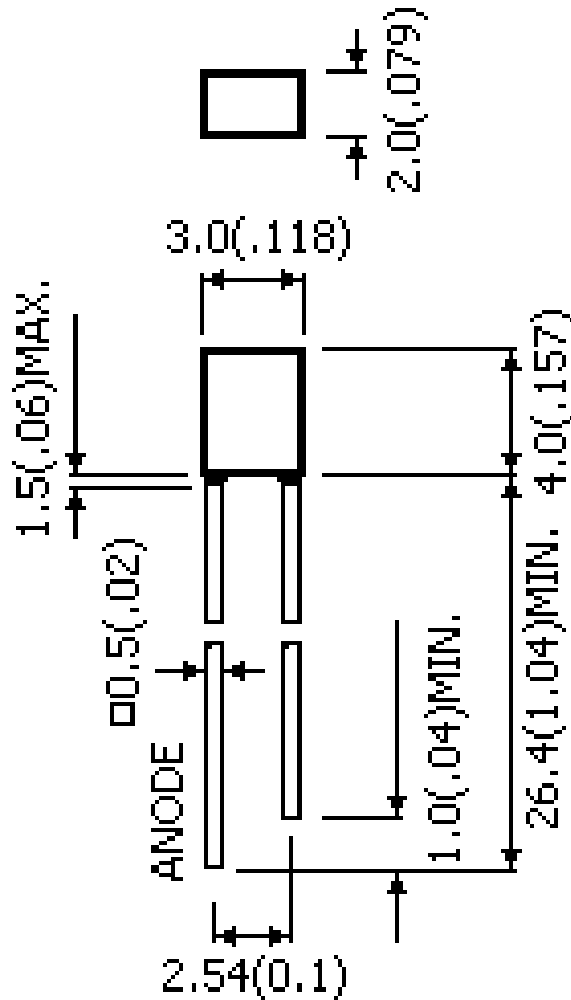


SPECIFICATIONS
CL234W4C
OUTLINES DIMENSIONS
Description

- *Rectangular Type
- *2mm x 3mm
- *Lens Color: Water Clear

Features

- *Emitting Color: White
- *High Luminous Intensity
- *Technology: InGaN
- *Chromaticity Coordinate
X =0.30, Y=0.31


Notes:

1. All Dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.25\text{mm}$ (0.01") unless otherwise noted.
3. Specifications are subject to change without notice.

Part Number	Chip Material	Color of Emission	Lens Type	Viewing Angle
CL234W4C	InGaN	White	Water Clear	95°



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ABSOLUTE MAXIMUM RATINGS
(TA=25°C)

Parameter	Symbol	Max Rating	Unit
Power Dissipation	P _D	85	mW
Pulse Current Forward Current	I _{FP}	100	mA
Continuous Forward Current	I _F	30	mA
Reverse Voltage	V _R	5	V
Operating Temperature Range	T _{OPR}	-40~+85	°C
Storage Temperature Range	T _{STG}	-40~+100	°C
I _{FP} = Pulse Width ≤ 10 ms, Duty Ratio ≤ 1/10. Soldering Condition: 260 °C/ 5sec			

OPTICAL-ELECTRICAL CHARACTERISTICS
(TA=25°C)

Parameter	Symbol	Test Condition	Value			Unit
			Min	Typ	Max	
Luminous Intensity	I _V	I _F = 20mA	300	550	-	mcd
Forward Voltage	V _F	I _F = 20mA	-	3.2	3.5	V
Reverse Leakage Current	I _R	V _R = 5V	-	-	10	μA
Viewing Angle	2θ _{1/2}	I _F = 20mA	-	95	-	deg
Chromaticity Coordinate	X	I _F = 20mA	-	0.30	-	-
Chromaticity Coordinate	Y	I _F = 20mA	-	0.31	-	-

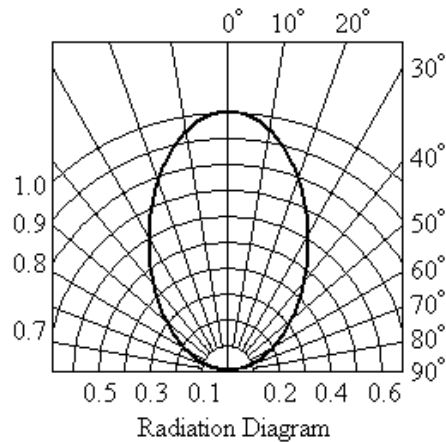
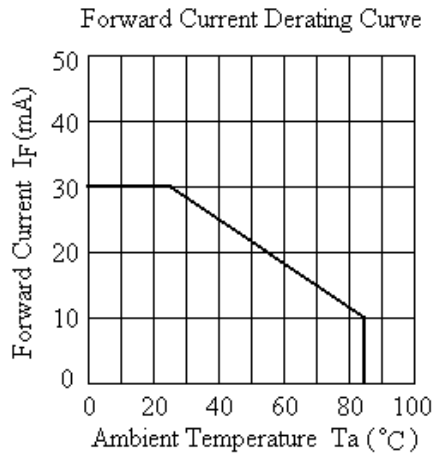
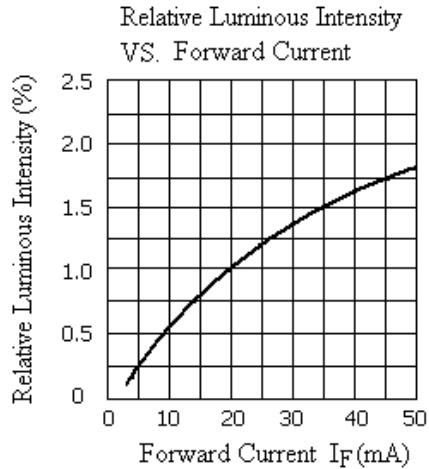
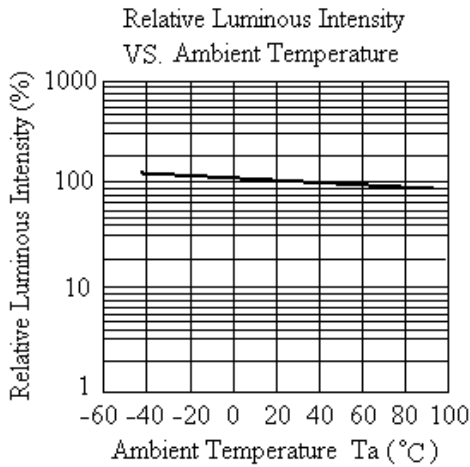
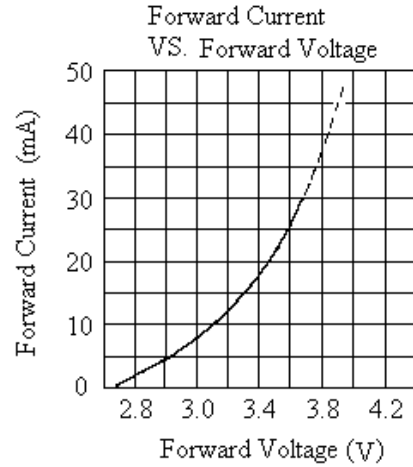
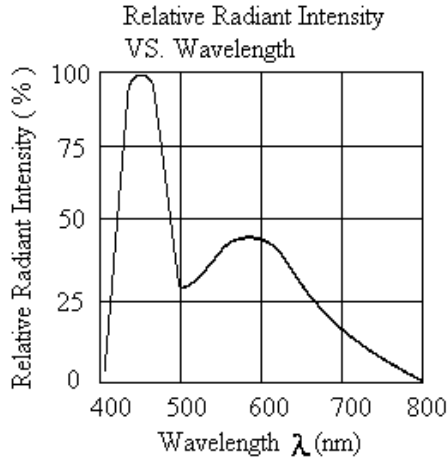
*Tolerance of viewing angle: -10 / +5 deg.



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OPTICAL CHARACTERISTIC CURVES

TYPICAL ELECTRO-OPTICAL CHARACTERISTIC CURVES



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SOLDERING CONDITIONS – LAMP TYPE LED

* Solder the LED no closer than 3mm from the base of the epoxy bulb. Soldering beyond the base of the tie bar is recommended.

* Recommended soldering conditions

Dip Soldering	
Pre-Heat	100 °C Max
Pre-Heat Time	60 Second Max
Solder Bath Temperature	260 °C Max
Dipping Time	5 Second Max
Dipping Position	No lower than 3mm from the base of the epoxy

Hand Soldering		
	3mm Series	Others
Temperature	300 °C Max	350 °C Max
Soldering Time	3 Second Max	3 Second Max
Position	No closer than 3mm from the base of the epoxy	No closer than 3mm from the base of the epoxy

* Do not apply any stress to the lead. Particularly when heated.

* The LED must not be repositioned after soldering.

* After soldering the LEDs, the epoxy bulb should be protected from mechanical shock or vibration until the LEDs return to room temperature.

* Direct soldering onto a PC board should be avoided. Mechanical stress to the resin may be caused by the PC board warping or from the clinching and cutting of the leadframes. When it is absolutely necessary, the LEDs may be mounted in this fashion, but, the user will assume responsibility for any problems. Direct soldering should only be done after testing has confirmed that no damage, such as wire bond failure or resin deterioration, will occur. LEDs should not be soldered directly to double sided PC boards because the heat will deteriorate the epoxy resin.

* When it is necessary to clamp the LEDs to prevent soldering failure, it is important to minimize the mechanical stress on the LEDs.

* Cut the LED leadframes at room temperature. Cutting the leadframes at high temperature may cause LED failure.



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